AiP8931R/AiP8932R/AiP8934R
7MHz 40V High-Slew-Rate Rail-to-Rail Output Amplifier

Product Specification

Specification Revision History：

Version	Date	Description
2025-09-A0	2025-09	New
2026-04-A1	2026-04	Modify parameters

Contents

1、General Description

AiP893XR is a 7MHz high-voltage, high-slew-rate rail-to-rail output amplifier, it operates over a supply voltage range of 3V to 40V, with a quiescent current of 1mA per amplifier and a gain-bandwidth product of 7MHz. It features a wide input common-mode voltage range and rail-to-rail output, making it suitable for motor control and industrial process control applications.

Features:

- Supply voltage: 3V to 40V
- Gain-bandwidth product: 7MHz
- Slew rate: 22V/μs
- Input offset voltage: ≤4mV
- Input common-mode voltage range: VSN to VSP-1.5 V
- Output short-circuit current: 38mA
- Open-loop voltage gain: 130dB
- Operating temperature: -40℃ to 125℃
- Package form:
  - AiP8931R：SOT23-5/SOP8
  - AiP8932R：SOP8/MSOP8/TSSOP8
  - AiP8934R：SOP14/TSSOP14

Ordering Information:

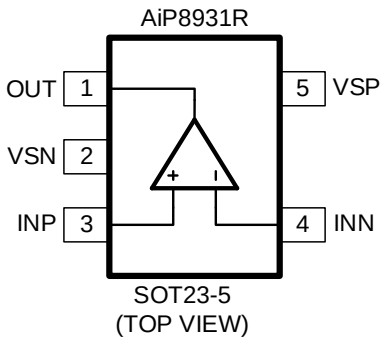
Reel packing specifications:

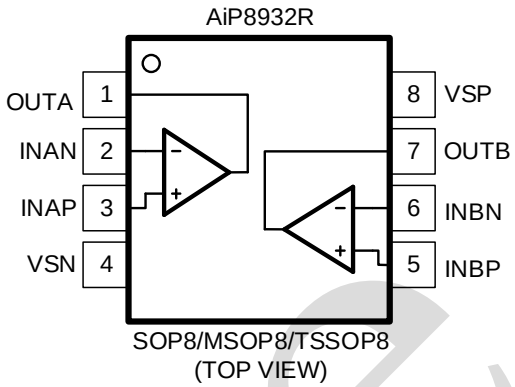
Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes	Moisture sensitivity level
AiP8931RGB235.TR	SOT23-5	8931R	3000PCS/reel	30000PCS/box	Dimensions of plastic enclosure: 2.9mm×1.6mm Pin spacing: 0.95mm	MSL3
AiP8931RSA8.TR	SOP8	AiP8931R	4000PCS/reel	8000PCS/box	Dimensions of plastic enclosure: 4.9mm×3.9mm Pin spacing: 1.27mm	MSL3
AiP8932RSA8.TR	SOP8	AiP8932R	4000PCS/reel	8000PCS/box	Dimensions of plastic enclosure: 4.9mm×3.9mm Pin spacing: 1.27mm	MSL3
AiP8932RMA8.TR	MSOP8	AiP8932R	5000PCS/reel	10000PCS/box	Dimensions of plastic enclosure: 3.0mm×3.0mm Pin spacing: 0.65mm	MSL3
AiP8932RTB8.TR	TSSOP8	8932R	5000PCS/reel	10000PCS/box	Dimensions of plastic enclosure: 4.4mm×3.0mm Pin spacing: 0.65mm	MSL3
AiP8934RSA14.TR	SOP14	AiP8934R	4000PCS/reel	8000PCS/box	Dimensions of plastic enclosure: 8.7mm×3.9mm Pin spacing: 1.27mm	MSL3
AiP8934RTA14.TR	TSSOP14	AiP8934R	5000PCS/reel	10000PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm	MSL3

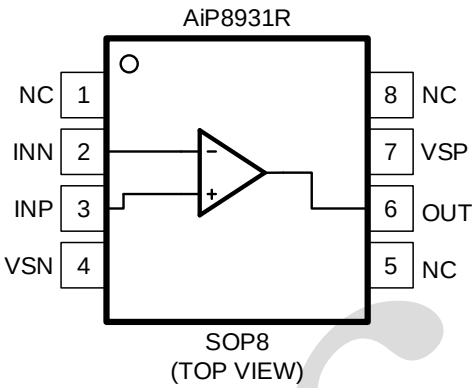
Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.

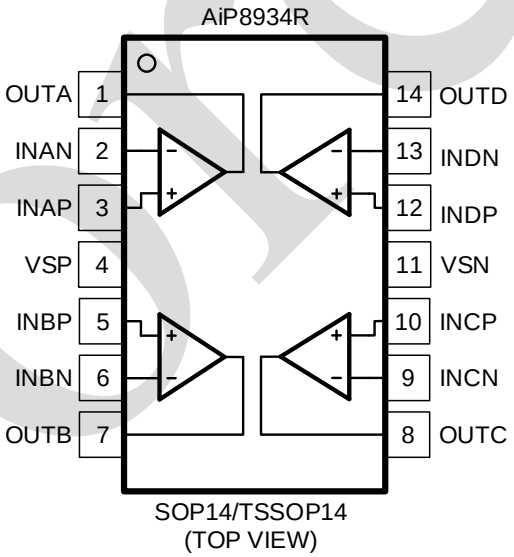
2、 Pin Description

2.1、Pin Configurations









2.2、Pin Description

AiP8931R: SOT23-5

Pin No.	Pin Name	Description
1	OUT	Output
2	VSN	Ground (negative power supply)
3	INP	Positive input
4	INN	Negative input
5	VSP	Power supply (positive power supply)

AiP8931R:SOP8

Pin No.	Pin Name	Description	Pin No.	Pin Name	Description
1	NC	No connect	5	NC	No connect
2	INN	Negative input	6	OUT	Output
3	INP	Positive input	7	VSP	Power supply (positive power supply)
4	VSN	Ground (negative power supply)	8	NC	No connect

AiP8932R: SOP8, MSOP8, TSSOP8

Pin No.	Pin Name	Description	Pin No.	Pin Name	Description
1	OUTA	A output	5	INBP	B positive input
2	INAN	A negative input	6	INBN	B negative input
3	INAP	A positive input	7	OUTB	B output
4	VSN	Ground (negative power supply)	8	VSP	Power supply (positive power supply)

AiP8934R: SOP14, TSSOP14

Pin No.	Pin Name	Description	Pin No.	Pin Name	Description
1	OUTA	A output	8	OUTC	C output
2	INAN	A negative input	9	INCN	C negative input
3	INAP	A positive input	10	INCP	C positive input
4	VSP	Power supply (positive power supply)	11	VSN	Ground (negative power supply)
5	INBP	B positive input	12	INDP	D positive input
6	INBN	B negative input	13	INDN	D negative input
7	OUTB	B output	14	OUTD	D output

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(T_{amb}=25℃, unless otherwise specified)

Characteristic	Symbol	Conditions	Min.	Max.	Unit
Supply voltage	VSP	-	-0.3	44	V
Differential input voltage	$\|V_{IN,DIFF}\|$	-	0	(VSP)-(VSN)	V
Ambient temperature	T_{amb}	-	-40	125	℃
Storage temperature	T_{stg}	-	-65	150	℃
Soldering temperature	T_L	10s	260		℃
Electrostatic discharge	ESD	HBM	8000		V

3.2、Recommended Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage (single power supply)	VS	3	-	40	V
Supply voltage (dual power supply)	VS	±1.5	-	±20	V
Ambient temperature	T_{amb}	-40	-	125	℃

3.3、Electrical Characteristics

(T_{amb}=25℃, VSP=30V, VCM=VSP/2, C_L=100pF, R_L=10KΩ and connected to VSP/2, unless otherwise specified)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
Quiescent current per amplifier	I_Q	AiP8931R	-	-	1.5	2	mA
			-40℃ to 125℃	-	-	3	
		AiP8932R AiP8934R	-	-	1	1.6	
			-40℃ to 125℃	-	-	2.5	
Input offset voltage	V_{OS}	-		-	0.5	-	mV
		-40℃ to 125℃		-4	-	4	
Input offset voltage drift	$\Delta V_{OS}/\Delta T$	-40℃～125℃		-	2	-	μV/℃
Input bias current	I_B	-40℃ to 125℃		-	20	1400	pA
Input offset current	I_{OS}	-40℃ to 125℃		-	7	-	pA
Different input current	I_{IN}	VS=36V, V_{ID}=36V		-	10	-	nA
Input capacitance	C_{IN}	Differential mode		-	5	-	pF
		Common mode		-	2.5	-	
Input common-mode voltage range	V_{CM}	-		VSN	-	VSP-1.5	V
Open-loop voltage gain	A_{OL}	-		95	130	-	dB
		-40℃ to 125℃		90	-	-	
Power supply rejection ratio	PSRR	-		95	120	-	dB
		-40℃ to 125℃		90	-	-	
Common-mode rejection ratio	CMRR	V_{CM}=0 to 28V	-	95	115	-	dB
			-40℃ to 125℃	90	-	-	
Output swing from positive rail	V_{OH}	R_L=10KΩ to VSP/2	-	-	0.25	0.6	V
			-40℃ to 125℃	-	-	1	
		R_L=2KΩ to VSP/2	-	-	1.2	1.5	
			-40℃ to 125℃	-	-	2.3	
Output swing from negative rail	V_{OL}	R_L=10KΩ to VSP/2	-	-	0.07	0.3	V
			-40℃ to 125℃	-	-	0.6	
		R_L=2KΩ to VSP/2	-	-	0.35	0.8	
			-40℃ to 125℃	-	-	1.6	
Output short-circuit current	I_{SC}	R_L=0 to VSP, sink		25	38	-	mA
		R_L=0 to VSN, source		25	38	-	
Gain-bandwidth product	GBP	G=100		-	7	-	MHz
Phase margin	PM	G=1		-	60	-	°
Gain margin	GM	G=1		-	10	-	dB
Overload recovery time	t_{OR}	G*VIN>VS		-	200	-	ns
Slew rate	SR	G=1, step=10V, rising edge		-	30	-	V/μs
		G=1, step=10V, falling edge		-	22	-	

Settling time	t_s-0.1%	G=11，step=2.5V	-	1	-	μs
	t_s-0.01%	G=11，step=2.5V	-	1.2	-	
Input voltage noise	E_N	f=0.1Hz to 10Hz	-	3.8	-	μV_{RMS}
Input voltage noise density	en	f=1KHz	-	30	-	nV/√Hz
		f=10KHz	-	15	-	
Input current noise	i_N	f=1KHz	-	2	-	fA/√Hz
Total harmonic distortion	THD	f=1KHz, G=1, RL=10KΩ, V_{OUT}=6V_{RMS}	-	0.0008	-	%

4、Characteristic Curve

(T_{amb}=25℃, VSP=30V, VCM=VSP/2, R_L=10KΩ and connected to VSP/2, unless otherwise specified)

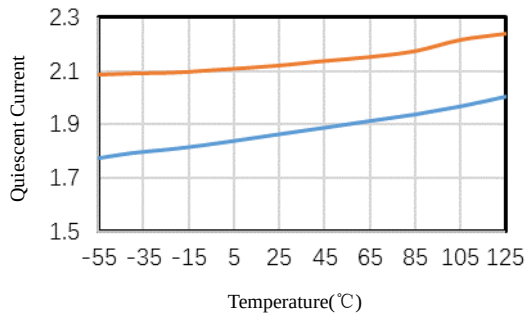


Figure 1. Quiescent Current vs. Temperature
(VS=5V)
AiP8932R, 2 Samples

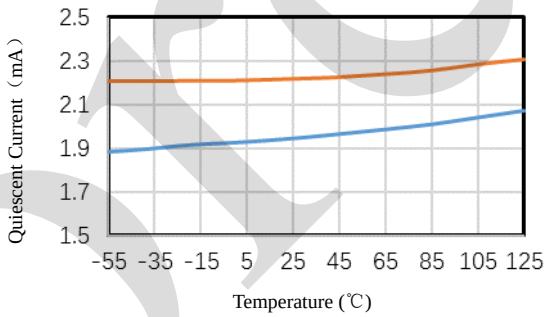


Figure 2. Quiescent Current vs. Temperature
(VS=30V)
AiP8932R, 2 Samples

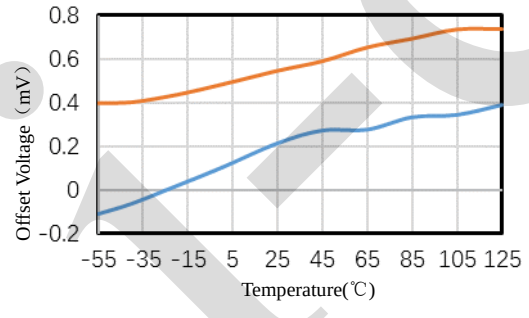


Figure 3. Offset Voltage vs. Temperature，2ch Data

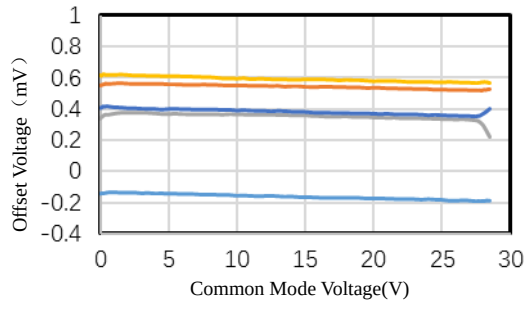


Figure 4. Offset Voltage vs. Common Mode Voltage，
5ch Data

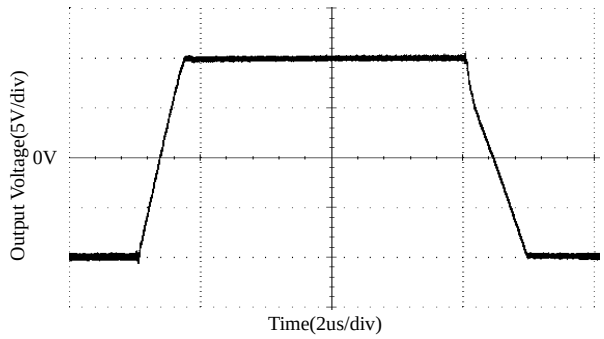


Figure 7. Large Signal Step Response
G=1，RL=10KΩ，CL=100pF

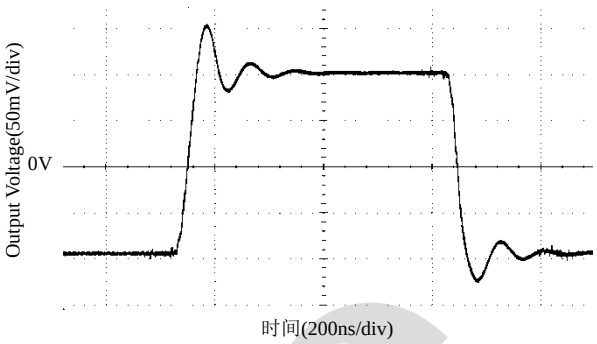


Figure 8. Small Signal Step Response
G=1，RL=10KΩ，CL=100pF

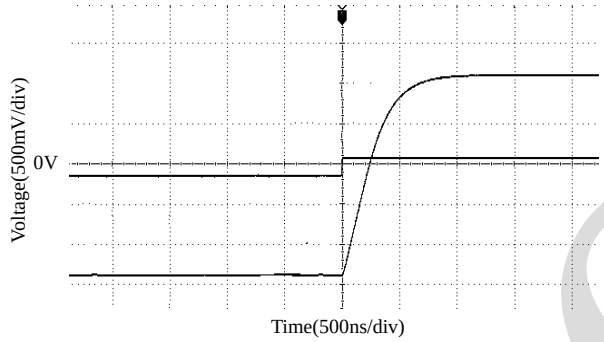


Figure 9. Positive Settling Time
VS=3.3V，VCM=1.65V，G=11

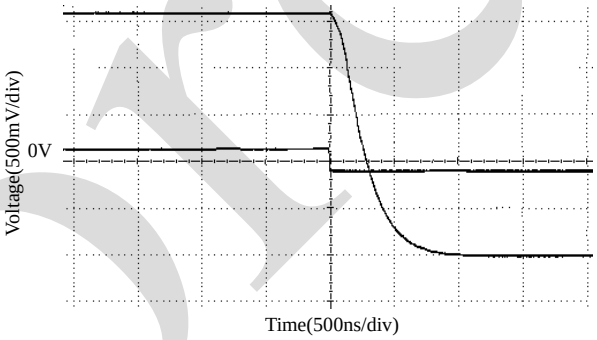


Figure 10. Negative Settling Time
VS=3.3V，VCM=1.65V，G=11

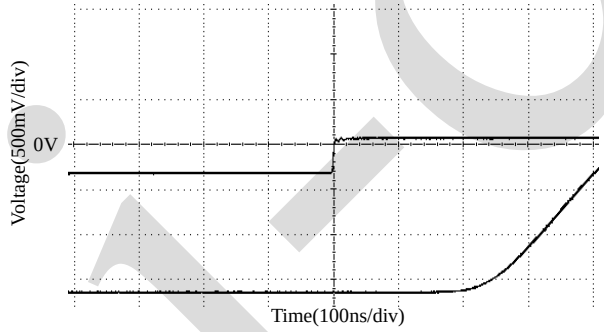


Figure 11. Positive Overload Recovery
VS=3.3V，VCM=1.65V，G=11

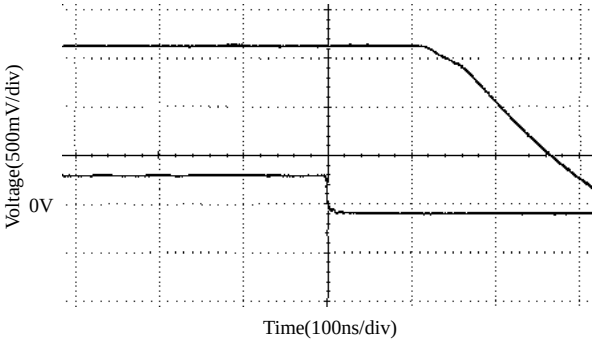


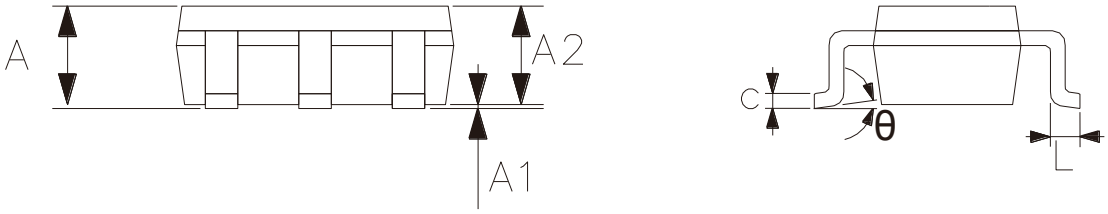
Figure 12. Negative Overload Recovery
VS=3.3V，VCM=1.65V，G=11

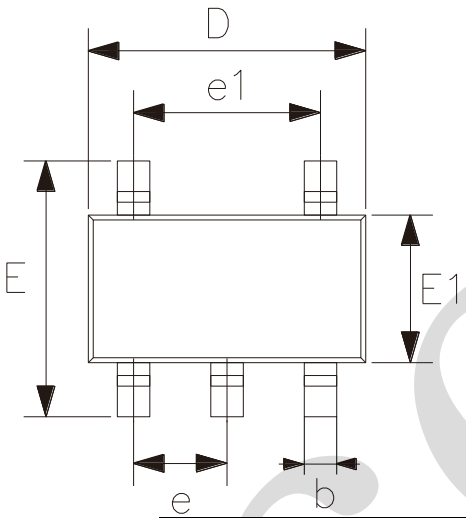
5、Function Description

AiP893XR is a 7MHz high-voltage, high-slew-rate rail-to-rail output amplifier, it operates over a supply voltage range of 3V to 40V, with an operating temperature range of -40℃ to 125℃. Each amplifier has a quiescent current of 1mA and a gain-bandwidth product of 7MHz. The input common-mode voltage range is VSN to VSP-1.5V. It adopts a CLASS AB output stage to deliver rail-to-rail output. In addition, an on-chip slew boost circuit is designed to achieve a high slew rate of 22V/μs.

6、Package Information

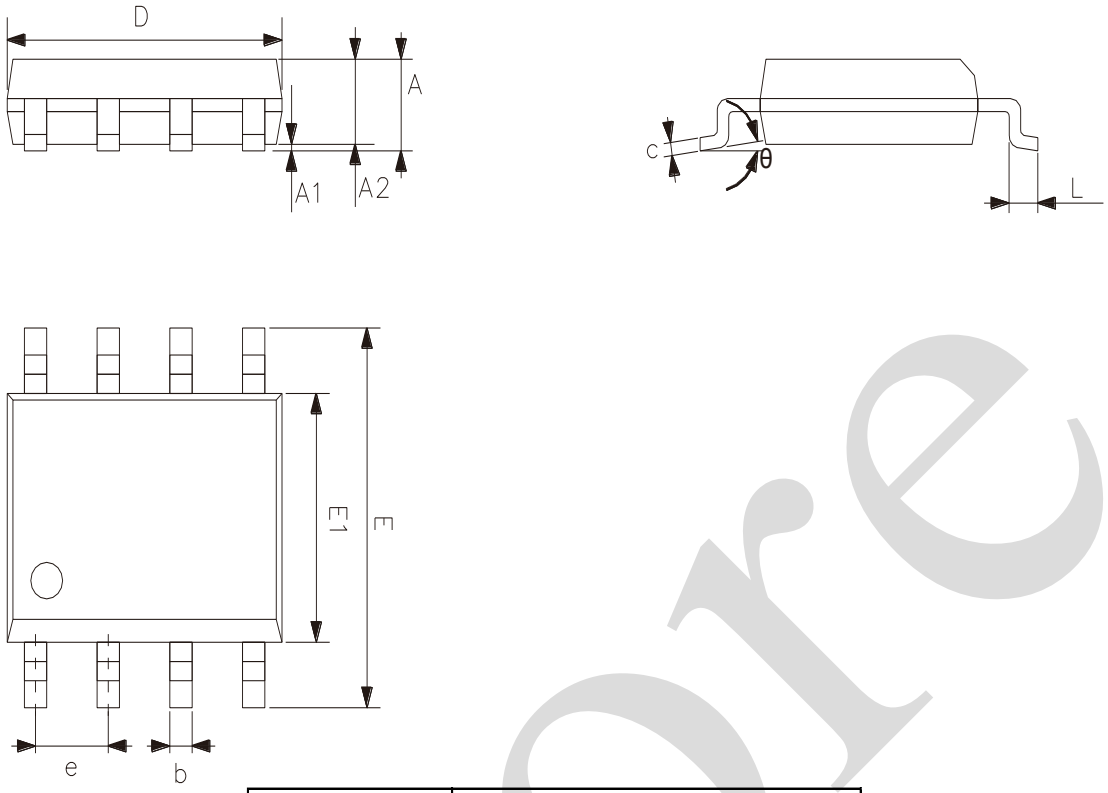
6.1、SOT23-5





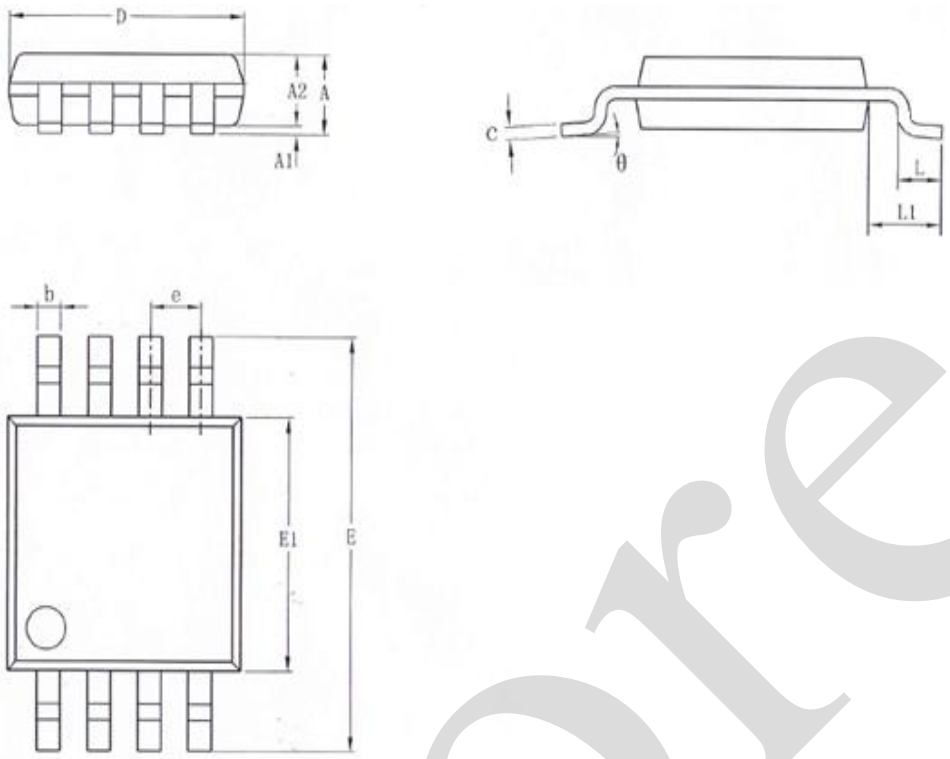
2023/12/A	Dimensions In Millimeters	
Symbol	Min.	Max.
A	—	1.26
A1	0.00	0.12
A2	1.00	1.20
b	0.30	0.50
c	0.10	0.20
D	2.82	3.02
E	2.60	3.00
E1	1.50	1.70
e	0.95	
e1	1.80	2.00
L	0.30	0.60
θ	0°	8°

6.2、SOP8



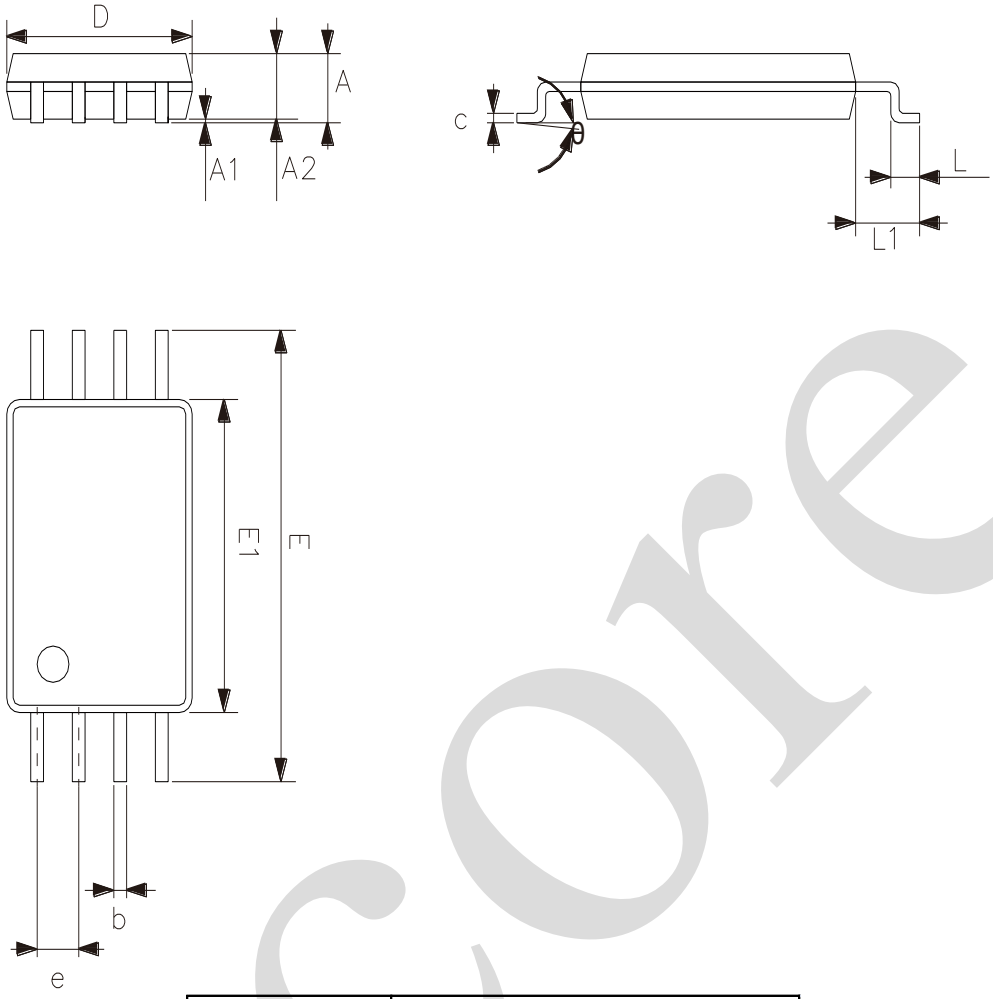
2023/12/A	Dimensions In Millimeters	
Symbol	**Min.**	**Max.**
A	1.35	1.80
A1	0.05	0.25
A2	1.25	1.55
D	4.70	5.10
E	5.80	6.30
E1	3.70	4.10
b	0.306	0.51
c	0.19	0.25
e	1.27	
L	0.40	0.89
θ	0°	8°

6.3、MSOP8



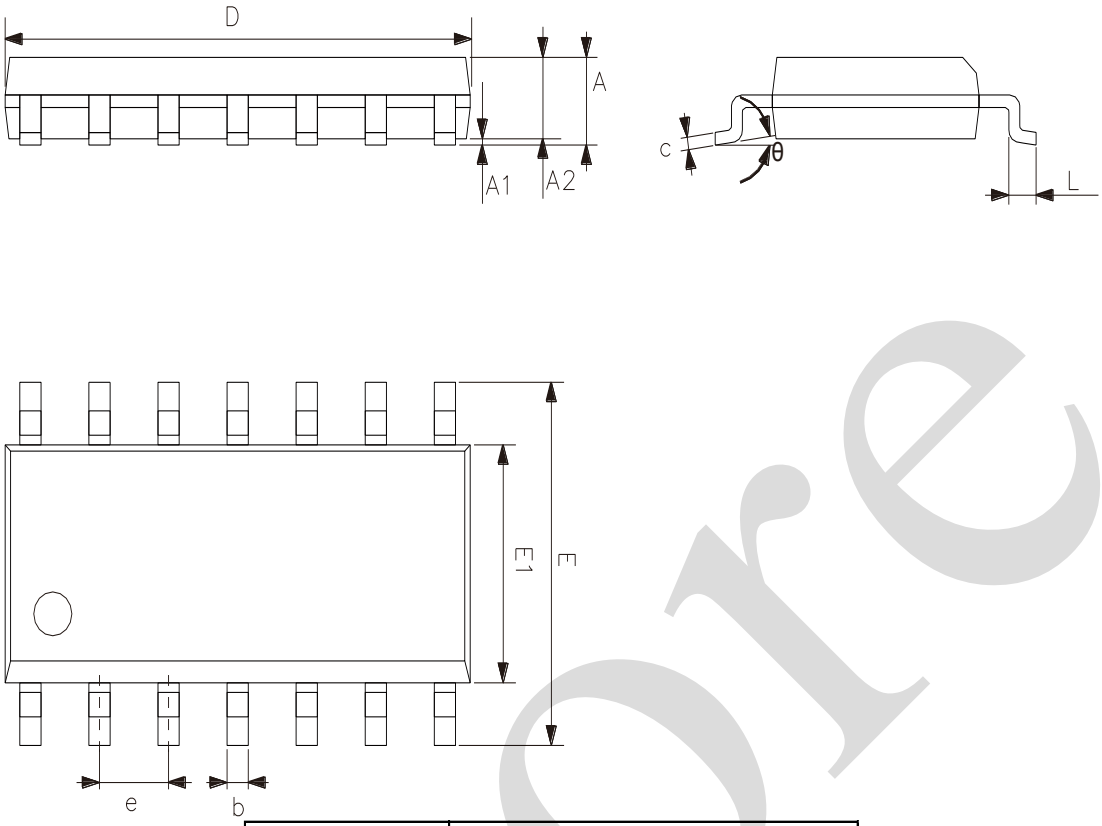
2023/12/A	Dimensions In Millimeters	
Symbol	**Min**	**Max**
A	—	1.10
A1	0.05	0.15
A2	0.75	0.95
b	0.22	0.38
c	0.08	0.23
D	2.90	3.10
E	4.70	5.10
E1	2.90	3.10
e	0.65	
L	0.40	0.80
L1	0.95	
θ	0°	8°

6.4、TSSOP8



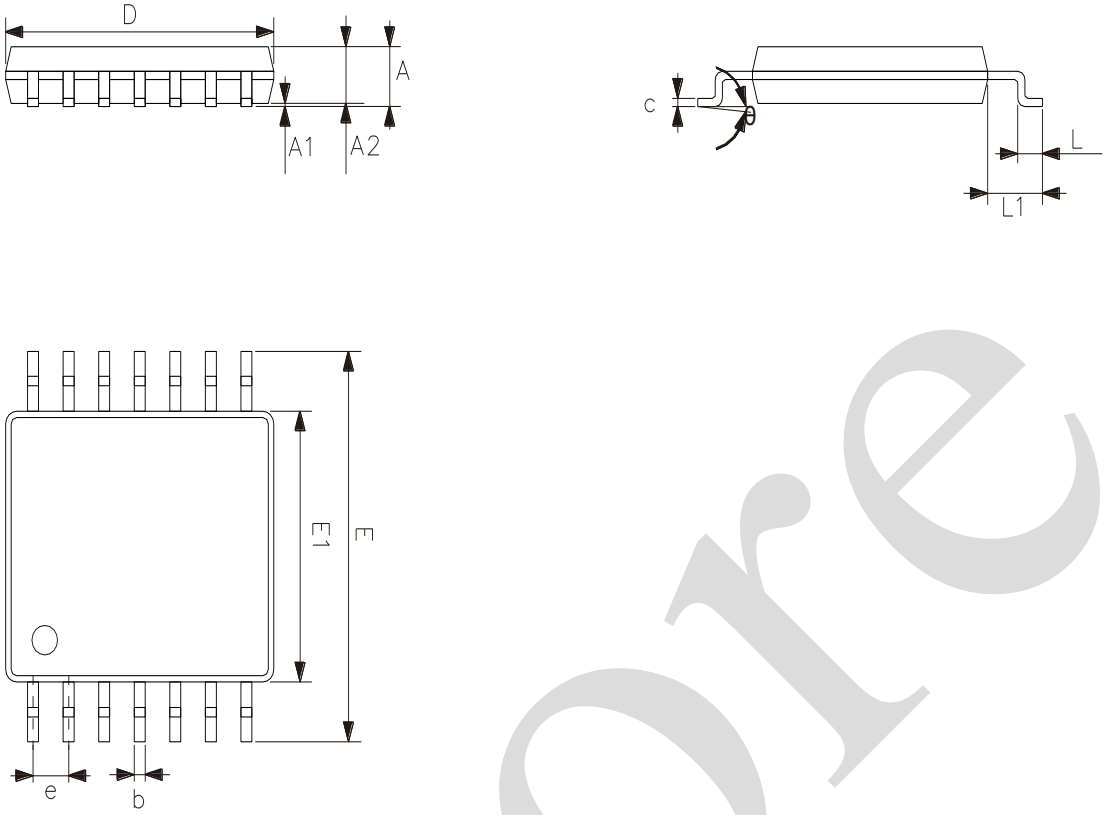
2023/12/A	Dimensions In Millimeters	
Symbol	**Min**	**Max**
A	—	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	2.90	3.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
L1	1.00	
θ	0°	8°

6.5、SOP14



2023/12/A	Dimensions In Millimeters	
Symbol	**Min.**	**Max.**
A	1.50	1.75
A1	0.05	0.25
A2	1.30	—
b	0.33	0.50
c	0.19	0.25
D	8.43	8.76
E	5.80	6.25
E1	3.75	4.00
e	1.27	
L	0.40	0.89
θ	0°	8°

6.6、TSSOP14



2023/12/A	Dimensions In Millimeters	
Symbol	**Min**	**Max**
A	—	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
L1	1.00	
θ	0°	8°

7、Statements And Notes

7.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

7.2、Notes

We recommend you to read this chapter carefully before using this product.

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